

# SOT1055-1

plastic thermal enhanced very thin quad flat package; no leads; 41 terminals; body 7 x 7 x 0.85 mm

8 February 2016

**Package information** 

## 1. Package summary

Terminal position code Q (quad)

Package type descriptive code HVQFN41

Package type industry code HVQFN41

Package style descriptive code HVQFN (thermal enhanced very thin quad

flatpack; no leads)

Package style suffix code NA (not applicable)

Package body material type P (plastic)

Mounting method type S (surface mount)

**Issue date** 23-1-2008

#### **Table 1. Package summary**

Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	6.9	-	7	7.1	mm
E	package width	6.9	-	7	7.1	mm
Α	seated height	[tbd]	-	0.85	1	mm
A <sub>2</sub>	package height	[tbd]	-	0.85	[tbd]	mm
n <sub>2</sub>	actual quantity of termination	-	-	41	-	



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### 2. Package outline

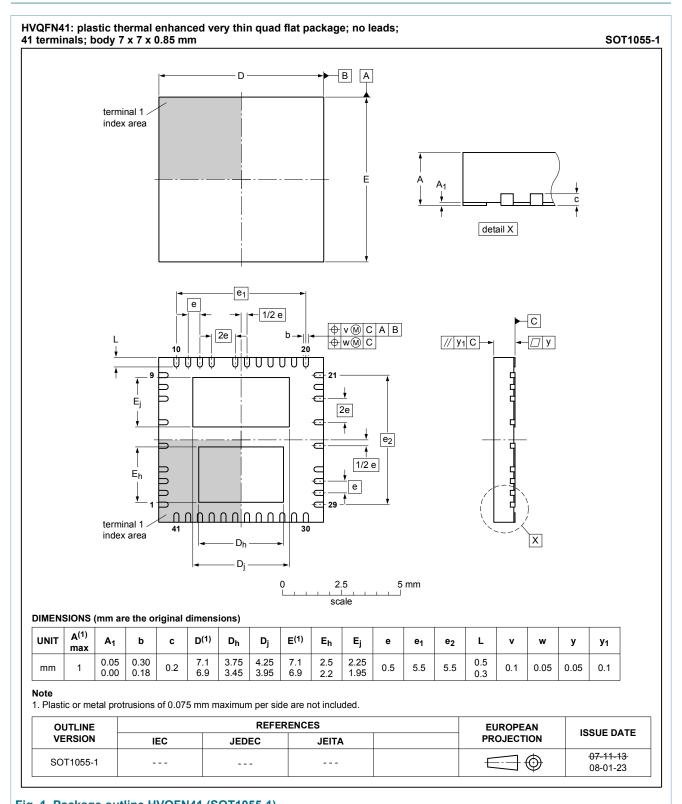


Fig. 1. Package outline HVQFN41 (SOT1055-1)

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### 3. Legal information

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